Language

- · Chinese (Native proficiency)
- · English (Professional working proficiency)

Skills

- Digital Light Printing (DLP) technology
- · Mechanical and thermal properties testing (Tensile, Impact, HDT, DSC tester)
- · Accelerated Weathering Tester
- · Innovation Yellow Belt certificate (six sigma)
- · Respond to Fire Incident in Workplace certificate
- · Transient Plant Source Method

Software

- ChemDraw
- · OriginLab
- · MS Office

Education

Master of Science in Industrial Chemistry (Distinction)

German Institute of Science and Technology, TUM-Asia, NUS, Singapore

- · NUS CAP 4.38/5
- TUM CAP 1.3/5 (1 for full CAP)

Bachelor of Engineering in Polymer Science and Materials

Sep 2015 - Jul 2019

Jul 2019 - Apr 2021

Northwestern Polytechnical University, NWPU, China

· GPA 87/100 (top 10%)

Research Experience

National College Students' Innovation and Entrepreneurship Training Program, China

May 2016 - Apr 2017 (Bachelor)

Program Code: 201610699271

- · Research on the fabrication of modified cyanate ester resins/ high modulus poly (p-phenylene-2,6benzobisoxazole) (HMPBO) fibers wave-transparent composite;
- · Soluble epoxy-terminated PBO precursor (epoxy-prePBO) was fabricated;
- · Wave-transparent composite with 7wt% epoxy-prePBO showed satisfactory dielectric constant (e, 2.68) and dielectric loss tangent (tand, 0.0061) values.

Study on Preparation of Dopamine-coated Boron Nitride/Polyimide (h-BN/PI) High Thermal Conductivity Composites, China

Dec 2018 - Jun 2019 (Bachelor)

- · h-BN nanoparticles modified by dopamine were fabricated;
- · Thermal properties of composites with the loading of 20vol% h-BN were improved (in-plane thermal conductivity as 3.009 W/mK). Research on the fabrication of modified cyanate ester resins/ high modulus poly (p-phenylene-2,6-benzobisoxazole) (HMPBO) fibers wave-transparent composite.

Work Experience

Chemist (Full time) Aug 2021 - Present

Evonik (SEA) Pte Ltd., Singapore

- · Daily lab work (formulation making, resin printing, testing, and housekeeping activities);
- Analyze lab data, independently summerize and make proposals for the further steps
- · Ability to operate DLP printers and troubleshoot or adjust printing parameters independently:
- · Work on ESTER system (EHSQ) to fulfill the safety of operating equipment in lab;
- · Assist in onboarding training of new joiners (Interns, contractors or trainees).

- · Participate in and conduct the formulation, printing and testing jobs for project Phoenix (INFINAM ST6100L, a photopolymer material exhibits excellent mechanical and high temperature resistance):
- · Conduct resin iteration, postcuring study, daily sample printing, characterization and aging study.
- · Participate in and work as a lead chemist in project Phlame (INFINAM FR 4100L, a photopolymer material exhibits flame retardant and mechanically durable after cured):
- · Optimize printing settings, postcuring study, aging and chemical resistance study, supporting data generation for IP work;
- Continuously work with customers to address the technical problems encountered.

Internship for Research & Development Work

July 2020 - Apr

2021

Evonik (SEA) Pte Ltd., Singapore

- · Formulate photopolymer resin and conduct 3D printing work
- $\boldsymbol{\cdot}$ Conduct mechanical and thermal properties testing for plastic materials
- · Participate in housekeeping and research discussion
- · Analyze data and responsible for development of projects and QC of the materials

Awards

· DAAD Scholarship CY 2020-2021 Outstanding Volunteer Award in IICC-X&NPUMUN Conference May 2018

· Honorable Mention Award in Mathematical Contest in Modeling/Interdisciplinary Contest in Modeling (MCM/ICM)

NWPU First-class Scholarship

· Distinguished Delegation Award in National MUN (NMUN-New York) · NWPU First-class Scholarship

NWPU First-class Scholarship

CY 2017 - 2018 Apr 2017

Apr 2018

CY 2016 - 2017

CY 2015 - 2016

Publications

- · Dongliang Ding, Zhihui Shang, Xu Zhang, Xingfeng Lei, Zhenguo Liu, Qiuyu Zhang, and Yanhui Chen. Creamics International, 2020 (Bachelor thesis work);
- · Tough Flame-Retardant Radiation Curable Composition for Additive Manufacturing (Halogen-free), 2023E00236 SG, Inventor, 2023 (Projetc Phlame).